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# BT137X-600G

4Q Triac 1 May 2015

**Product data sheet** 

## 1. General description

Planar passivated four quadrant triac in a SOT186A "full pack" plastic package intended for use in general purpose bidirectional switching and phase control applications.

## 2. Features and benefits

- High blocking voltage capability
- Isolated package
- Least sensitive gate for highest noise immunity
- Planar passivated for voltage ruggedness and reliability
- Triggering in all four quadrants

## 3. Applications

- General purpose motor control
- General purpose switching

## 4. Quick reference data

| Symbol              | Parameter                                | Conditions  | Min | Тур | Мах | Unit |
|---------------------|--|---|-----|-----|-----|------|
| V <sub>DRM</sub>    | repetitive peak off-<br>state voltage    |   | -   | -   | 600 | V    |
| I <sub>TSM</sub>    | non-repetitive peak on-<br>state current | full sine wave; $T_{j(init)} = 25 \text{ °C};$<br>$t_p = 20 \text{ ms}; \text{ Fig. 4}; \text{ Fig. 5}$ | -   | -   | 65  | A    |
| I <sub>T(RMS)</sub> | RMS on-state current                     | full sine wave; $T_h \le 73$ °C; Fig. 1; Fig. 2;<br>Fig. 3  | -   | -   | 8   | A    |
| Static chara        | acteristics                              |   | Ì   |     |     |      |
| I <sub>GT</sub>     | gate trigger current                     | $V_D = 12 V; I_T = 0.1 A; T2+G+;$<br>$T_j = 25 °C; Fig. 7$  | -   | 5   | 50  | mA   |
|                     |  | $V_D = 12 V; I_T = 0.1 A; T2+ G-;$<br>$T_j = 25 °C; Fig. 7$   | -   | 8   | 50  | mA   |
|                     |  | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T2- G-;<br>T <sub>j</sub> = 25 °C; <u>Fig. 7</u>         | -   | 11  | 50  | mA   |
|                     |  | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T2- G+;<br>T <sub>i</sub> = 25 °C; <u>Fig. 7</u>         | -   | 30  | 100 | mA   |







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## 5. Pinning information

| Table 2. | Pinning | information             |                    |                |
|----------|---------|-------------------------|--------------------|----------------|
| Pin      | Symbol  | Description             | Simplified outline | Graphic symbol |
| 1        | T1      | main terminal 1         | mb                 | T2-71          |
| 2        | T2      | main terminal 2         |                    | Sym051         |
| 3        | G       | gate                    |                    |                |
| mb       | n.c.    | mounting base; isolated |                    |                |
|          |         |                         |                    |                |
|          |         |                         | 1 2 3              |                |
|          |         |                         | TO-220F (SOT186A)  |                |

## 6. Ordering information

| Table 3. Ordering in | formation |   |         |
|----------------------|-----------|---|---------|
| Type number          | Package   |   |         |
|                      | Name      | Description   | Version |
| BT137X-600G          | TO-220F   | plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack" | SOT186A |

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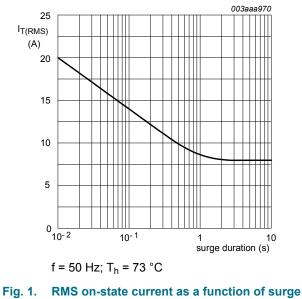
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## 7. Limiting values

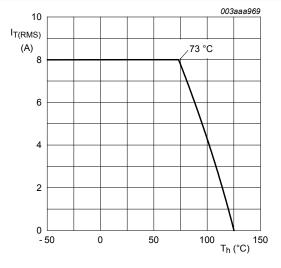
#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                            | Conditions   | Min | Max | Unit             |
|---------------------|--------------------------------------|--|-----|-----|------------------|
| V <sub>DRM</sub>    | repetitive peak off-state voltage    |  | -   | 600 | V                |
| I <sub>T(RMS)</sub> | RMS on-state current                 | full sine wave; T <sub>h</sub> ≤ 73 °C; <u>Fig. 1; Fig. 2;</u><br><u>Fig. 3</u>                          | -   | 8   | A                |
| I <sub>TSM</sub>    | non-repetitive peak on-state current | full sine wave; $T_{j(init)} = 25 \text{ °C}$ ;<br>$t_p = 20 \text{ ms}$ ; <u>Fig. 4</u> ; <u>Fig. 5</u> | -   | 65  | A                |
|                     |                                      | full sine wave; $T_{j(init)} = 25 \text{ °C};$<br>$t_p = 16.7 \text{ ms}$                                | -   | 71  | A                |
| l <sup>2</sup> t    | I <sup>2</sup> t for fusing          | t <sub>p</sub> = 10 ms; SIN  | -   | 21  | A <sup>2</sup> s |
| dI <sub>T</sub> /dt | rate of rise of on-state current     | I <sub>G</sub> = 100 mA; T2+ G+  | -   | 50  | A/µs             |
|                     |                                      | I <sub>G</sub> = 100 mA; T2+ G-  | -   | 50  | A/µs             |
|                     |                                      | I <sub>G</sub> = 200 mA; T2- G+  | -   | 10  | A/µs             |
|                     |                                      | I <sub>G</sub> = 100 mA; T2- G-  | -   | 50  | A/µs             |
| I <sub>GM</sub>     | peak gate current                    |  | -   | 2   | А                |
| P <sub>GM</sub>     | peak gate power                      |  | -   | 5   | W                |
| P <sub>G(AV)</sub>  | average gate power                   | over any 20 ms period  | -   | 0.5 | W                |
| T <sub>stg</sub>    | storage temperature                  |  | -40 | 150 | °C               |
| Tj                  | junction temperature                 |  | -   | 125 | °C               |



duration; maximum values



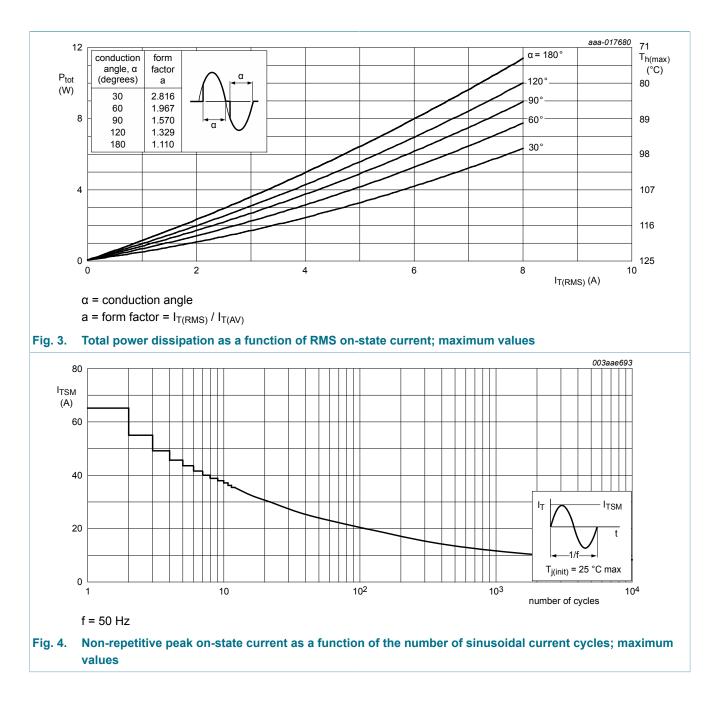


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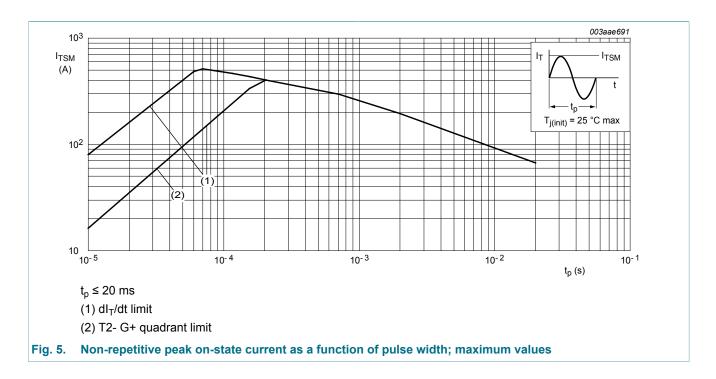


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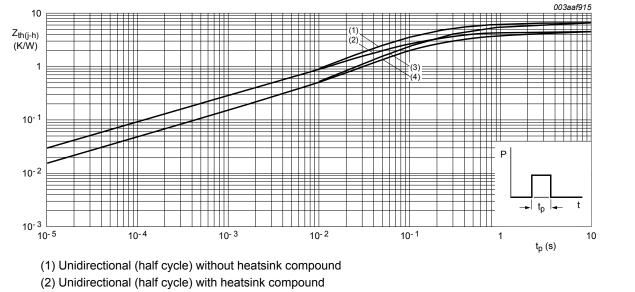


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## 8. Thermal characteristics

| Table 5. The         | ermal characteristics                             |   |     |     |     |      |
|----------------------|---|---|-----|-----|-----|------|
| Symbol               | Parameter   | Conditions  | Min | Тур | Max | Unit |
| R <sub>th(j-h)</sub> | thermal resistance from junction to               | full or half cycle; without heatsink compound; Fig. 6 | -   | -   | 6.5 | K/W  |
|                      | heatsink  | full or half cycle; with heatsink compound; Fig. 6    | -   | -   | 4.5 | K/W  |
| R <sub>th(j-a)</sub> | thermal resistance<br>from junction to<br>ambient | in free air   | -   | 55  | -   | K/W  |



- (3) Bidirectional (full cycle) without heatsink compound
- (4) Bidirectional (full cycle) with heatsink compound
- Fig. 6. Transient thermal impedance from junction to heatsink as a function of pulse duration

## 9. Isolation characteristics

| Table 6. Isol          | ation characteristics |   |     |     |      |      |
|------------------------|-----------------------|---|-----|-----|------|------|
| Symbol                 | Parameter             | Conditions  | Min | Тур | Max  | Unit |
| V <sub>isol(RMS)</sub> | RMS isolation voltage | from all terminals to external heatsink;<br>sinusoidal waveform; clean and dust<br>free; 50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %;<br>T <sub>h</sub> = 25 °C | -   | -   | 2500 | V    |
| C <sub>isol</sub>      | isolation capacitance | from main terminal 2 to external<br>heatsink; f = 1 MHz; T <sub>h</sub> = 25 °C   | -   | 10  | -    | pF   |

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## **10. Characteristics**

| Symbol                | Parameter                             | Conditions   | Min  | Тур | Max  | Unit |
|-----------------------|---------------------------------------|--|------|-----|------|------|
| Static chara          | acteristics                           |  |      |     |      |      |
| I <sub>GT</sub>       | gate trigger current                  | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T2+ G+;<br>T <sub>j</sub> = 25 °C; <u>Fig. 7</u>                                  | -    | 5   | 50   | mA   |
|                       |                                       | $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G-};$<br>$T_j = 25 \text{ °C}; \text{ Fig. 7}$                      | -    | 8   | 50   | mA   |
|                       |                                       | $V_D$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G-;<br>T <sub>j</sub> = 25 °C; <u>Fig. 7</u>   | -    | 11  | 50   | mA   |
|                       |                                       | $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G+};$<br>$T_j = 25 \text{ °C}; \text{ Fig. 7}$                      | -    | 30  | 100  | mA   |
| l                     | latching current                      | $V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2+ G+};$<br>$T_j = 25 \text{ °C}; \text{ Fig. 8}$                      | -    | 7   | 45   | mA   |
|                       |                                       | $V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2+ G-};$<br>$T_j = 25 \text{ °C}; \text{ Fig. 8}$                      | -    | 16  | 60   | mA   |
|                       |                                       | $V_D$ = 12 V; I <sub>G</sub> = 0.1 A; T2- G-;<br>T <sub>j</sub> = 25 °C; <u>Fig. 8</u>   | -    | 5   | 45   | mA   |
|                       |                                       | $V_D$ = 12 V; I <sub>G</sub> = 0.1 A; T2- G+;<br>T <sub>j</sub> = 25 °C; <u>Fig. 8</u>   | -    | 7   | 60   | mA   |
| I <sub>H</sub>        | holding current                       | V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>   | -    | 5   | 40   | mA   |
| V <sub>T</sub>        | on-state voltage                      | I <sub>T</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>  | -    | 1.3 | 1.65 | V    |
| V <sub>GT</sub>       | gate trigger voltage                  | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C;<br>Fig. 11  | -    | 0.7 | 1    | V    |
|                       |                                       | V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 125 °C;<br>Fig. 11  | 0.25 | 0.4 | -    | V    |
| I <sub>D</sub>        | off-state current                     | V <sub>D</sub> = 600 V; T <sub>j</sub> = 125 °C  | -    | 0.1 | 0.5  | mA   |
| Dynamic ch            | aracteristics                         | I  |      |     | 1    |      |
| dV <sub>D</sub> /dt   | rate of rise of off-state voltage     | $V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit | 200  | 250 | -    | V/µs |
| dV <sub>com</sub> /dt | rate of change of commutating voltage | $V_D$ = 400 V; T <sub>j</sub> = 95 °C; dI <sub>com</sub> /dt = 3.6 A/<br>ms; I <sub>T</sub> = 8 A                                | 10   | 20  | -    | V/µs |
| t <sub>gt</sub>       | gate-controlled turn-on time          | $I_{TM}$ = 12 A; $V_D$ = 600 V; $I_G$ = 0.1 A; $dI_G/dt$ = 5 A/µs  | -    | 2   | -    | μs   |

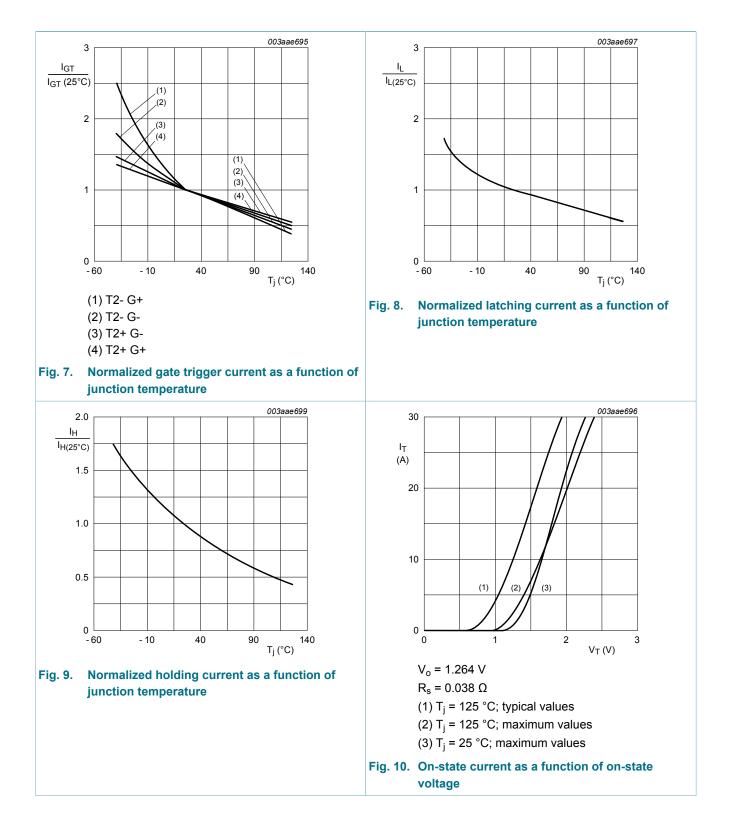


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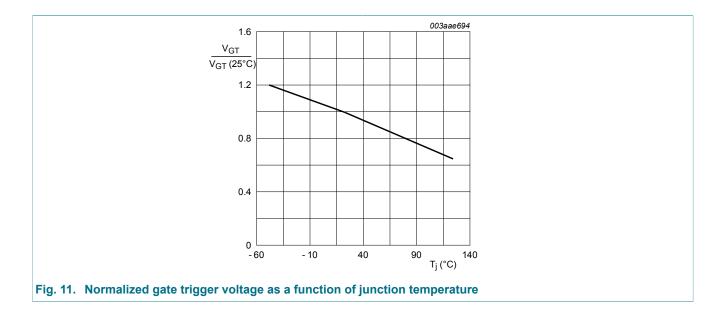
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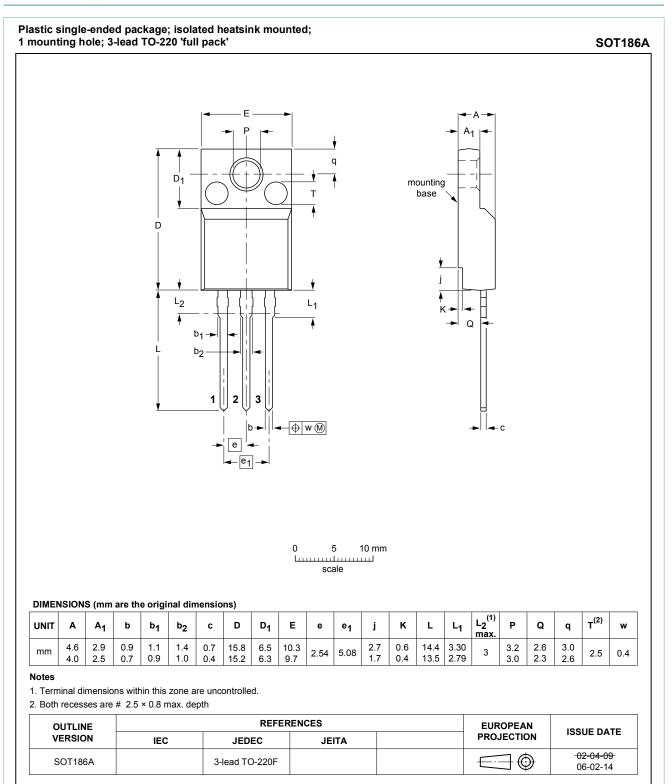
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## **11. Package outline**



#### Fig. 12. Package outline TO-220F (SOT186A)

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|--------------------------------------|-----------------------|---|
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